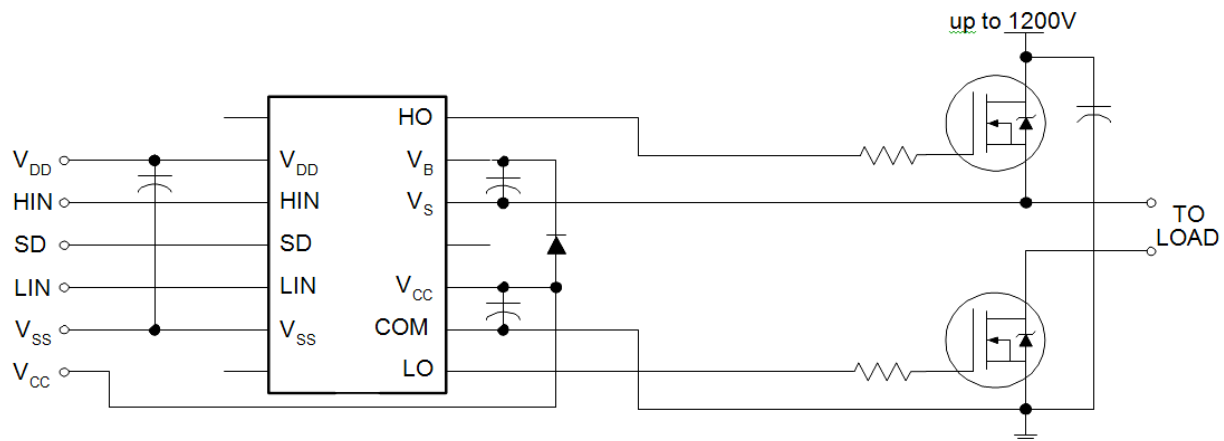


Typical Connection Diagram



Refer to Lead Assignments for correct pin configuration. This/These diagram(s) show electrical connections only. Please refer to our Application Notes and Design Tips for proper circuit board layout

Absolute Maximum Ratings

Absolute Maximum Ratings indicate sustained limits beyond which damage to the device may occur. All voltage parameters are absolute voltages referenced to COM. The Thermal Resistance and Power Dissipation ratings are measured under board mounted and still air conditions.

Symbol	Definition	Min.	Max.	Units
V_B	High Side Floating Supply Voltage	-0.3	1225	V
V_S	High Side Floating Supply Offset Voltage	$V_B - 25$	$V_B + 0.3$	
V_{HO}	High Side Floating Output Voltage	$V_S - 0.3$	$V_B + 0.3$	
V_{CC}	Low Side Fixed Supply Voltage	-0.3	25	
V_{LO}	Low Side Output Voltage	-0.3	$V_{CC} + 0.3$	
V_{DD}	Logic Supply Voltage	-0.3	$V_{SS} + 25$	
V_{SS}	Logic Supply Offset Voltage	$V_{CC} - 25$	$V_{CC} + 0.3$	
V_{IN}	Logic Input Voltage (HIN, LIN & SD)	$V_{SS} - 0.3$	$V_{DD} + 0.3$	
dV_S/dt	Allowable Offset Supply Voltage Transient (Figure 2)	—	50	V/ns
P_D	Package Power Dissipation @ $T_A \leq +25^\circ\text{C}$	(14 Lead PDIP)	1.3	W
		(16 Lead SOIC)	1.0	
R_{THJA}	Thermal Resistance, Junction to Ambient	(14 Lead PDIP)	75	$^\circ\text{C/W}$
		(16 Lead SOIC)	100	
T_J	Junction Temperature	—	125	$^\circ\text{C}$
T_S	Storage Temperature	-55	150	
T_L	Lead Temperature (Soldering, 10 seconds)	—	300	

Recommended Operating Conditions

The Input / Output logic timing diagram is shown in Figure 1. For proper operation the device should be used within the recommended conditions. The V_S and V_{SS} offset ratings are tested with all supplies biased at 15 V differential.

Symbol	Definition	Min.	Max.	Units
V_B	High Side Floating Supply Absolute Voltage	$V_S + 12$	$V_S + 20$	V
V_S	High Side Floating Supply Offset Voltage	†	1200	
V_{HO}	High Side Floating Output Voltage	V_S	V_B	
V_{CC}	Low Side Fixed Supply Voltage	12	20	
V_{LO}	Low Side Output Voltage	0	V_{CC}	
V_{DD}	Logic Supply Voltage	$V_{SS} + 3$	$V_{SS} + 20$	
V_{SS}	Logic Supply Offset Voltage	-5 ^{††}	5	
V_{IN}	Logic Input Voltage (HIN, LIN & SD)	V_{SS}	V_{DD}	

† Logic operational for V_S of -5 to +1200V. Logic state held for V_S of -5V to $-V_{BS}$. (Please refer to the Design Tip DT97-3 for more details).

†† When $V_{DD} < 5V$, the minimum V_{SS} offset is limited to $-V_{DD}$

Dynamic Electrical Characteristics

V_{BIAS} (V_{CC} , V_{BS} , V_{DD}) = 15 V, C_L = 1000 pF, T_A = 25 °C and V_{SS} = COM unless otherwise specified. The dynamic electrical characteristics are measured using the test circuit shown in Figure 3.

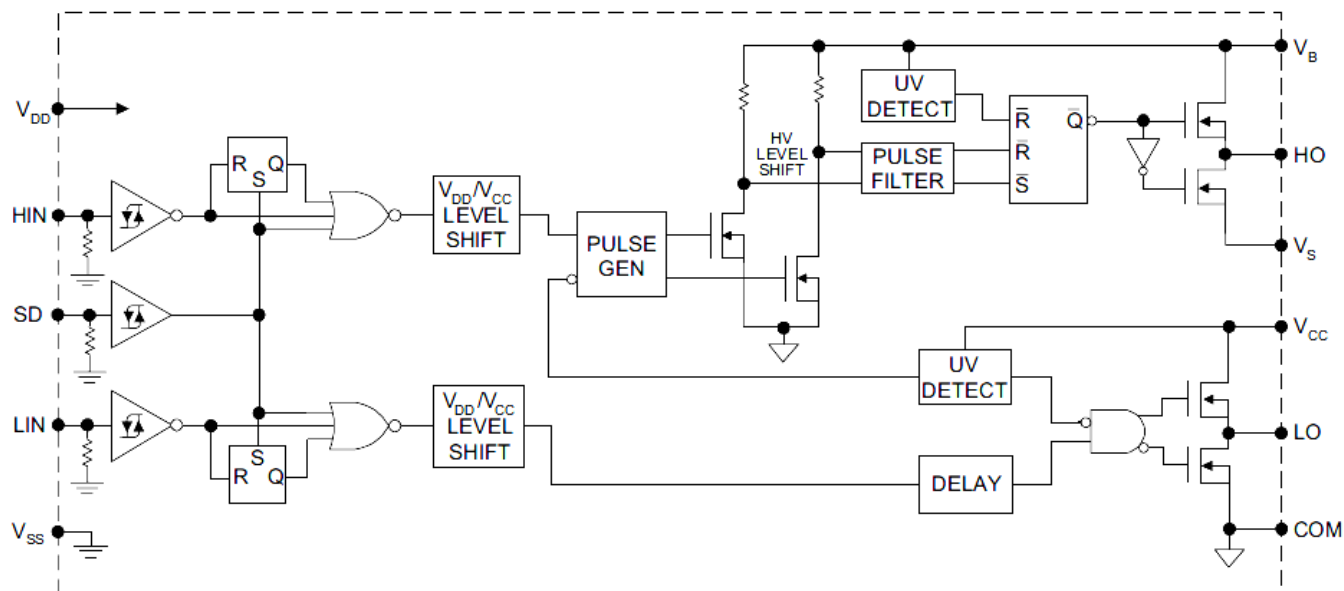
Symbol	Definition	Min.	Typ.	Max.	Units	Test Conditions
t_{on}	Turn-On Propagation Delay	—	280	—	ns	$V_S = 0V$
t_{off}	Turn-Off Propagation Delay	—	225	—		$V_S = 1200V$
t_{sd}	Shutdown Propagation Delay	—	230	—		$V_S = 1200V$
t_r	Turn-On Rise Time	—	25	—		
t_f	Turn-Off Fall Time	—	17	—		
MT	Delay Matching, HS & LS Turn-On/Off	—	—	30		

Static Electrical Characteristics

V_{BIAS} (V_{CC} , V_{BS} , V_{DD}) = 15 V, T_A = 25 °C and V_{SS} = COM unless otherwise specified. The V_{IN} , V_{TH} and I_{IN} parameters are referenced to V_{SS} and are applicable to all three logic input leads: HIN, LIN and SD. The V_O and I_O parameters are referenced to COM and are applicable to the respective output leads: HO or LO.

Symbol	Definition	Min.	Typ.	Max.	Units	Test Conditions
V_{IH}	Logic "1" Input Voltage	9.5	—	—	V	
V_{IL}	Logic "0" Input Voltage	—	—	6.0		
V_{OH}	High Level Output Voltage, $V_{BIAS} - V_O$	—	—	1.2		$I_O = 0A$
V_{OL}	Low Level Output Voltage, V_O	—	—	0.1		$I_O = 0A$
I_{LK}	Offset Supply Leakage Current	—	—	50	μA	$V_B = V_S = 1200V$
I_{QBS}	Quiescent V_{BS} Supply Current	—	125	230		$V_{IN} = 0V$ or V_{DD}
I_{QCC}	Quiescent V_{CC} Supply Current	—	180	340		$V_{IN} = 0V$ or V_{DD}
I_{QDD}	Quiescent V_{DD} Supply Current	—	15	30		$V_{IN} = 0V$ or V_{DD}
I_{IN+}	Logic "1" Input Bias Current	—	20	40		$V_{IN} = V_{DD}$
I_{IN-}	Logic "0" Input Bias Current	—	—	1.0		$V_{IN} = 0V$
V_{BSUV+}	V_{BS} Supply Undervoltage Positive Going Threshold	8.7	10.2	11.7	V	
V_{BSUV-}	V_{BS} Supply Undervoltage Negative Going Threshold	7.9	9.3	10.7		
V_{CCUV+}	V_{CC} Supply Undervoltage Positive Going Threshold	8.7	10.2	11.7		
V_{CCUV-}	V_{CC} Supply Undervoltage Negative Going Threshold	7.9	9.3	10.7		
I_{O+}	Output High Short Circuit Pulsed Current	1.7	2.0	—	A	$V_O = 0V, V_{IN} = V_{DD}$ $PW \leq 10 \mu s$
I_{O-}	Output Low Short Circuit Pulsed Current	2.0	2.5	—		$V_O = 15V, V_{IN} = 0V$ $PW \leq 10 \mu s$

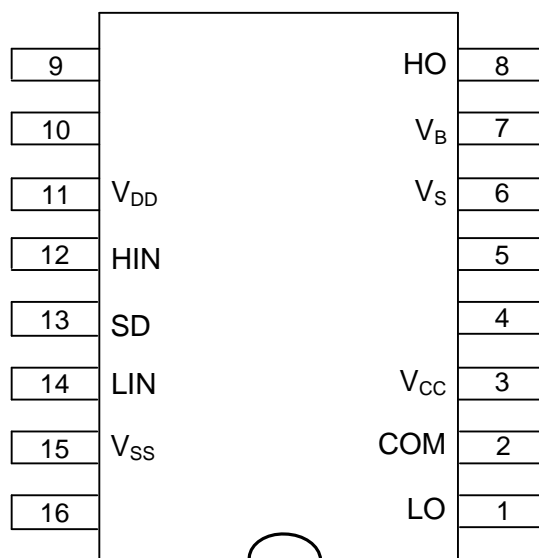
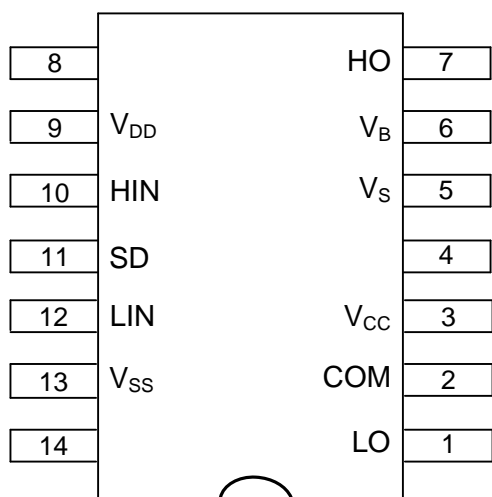
Functional Block Diagram



Lead Definitions

Symbol	Description
V_{DD}	Logic Supply
HIN	Logic Input for High Side Gate Driver Output (HO), In Phase
SD	Logic Input for Shutdown
LIN	Logic Input for Low Side Gate Driver Output (LO), In Phase
V_{SS}	Logic Ground
V_B	High Side Floating Supply
HO	High Side Gate Drive Output
V_S	High Side Floating Supply Return
V_{CC}	Low Side Supply
LO	Low Side Gate Drive Output
COM	Low Side Return

Lead Assignments



Application Information and Additional Information

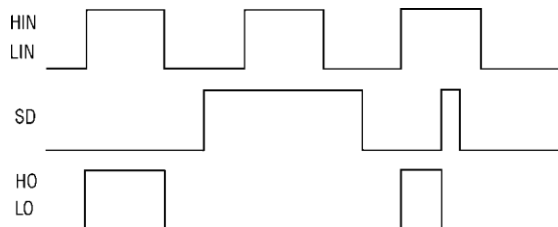


Figure 1. Input / Output Timing Diagram

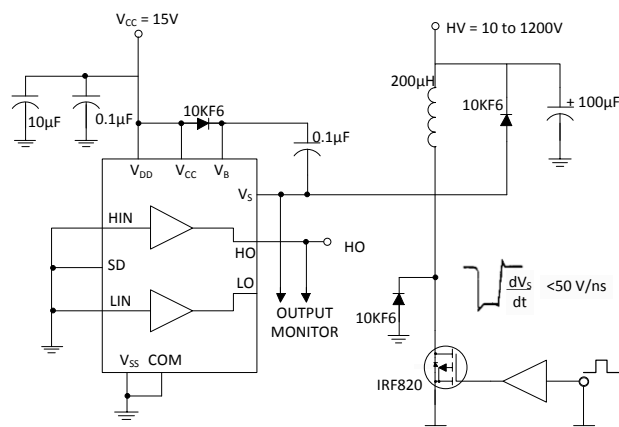


Figure 2. Floating Supply Voltage Transient Test Circuit

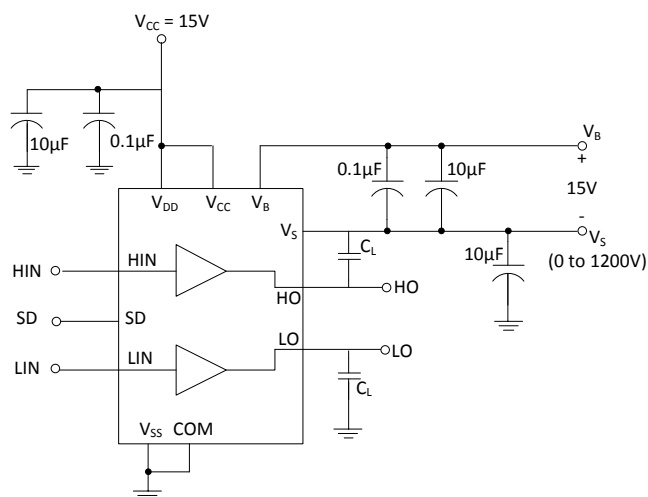


Figure 3. Switching Time Test Circuit

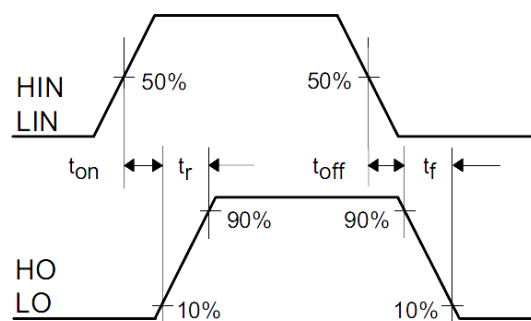


Figure 4. Switching Time Waveform Definition

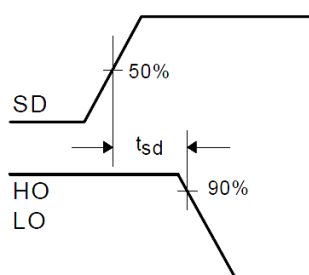


Figure 5. Shutdown Waveform Definitions

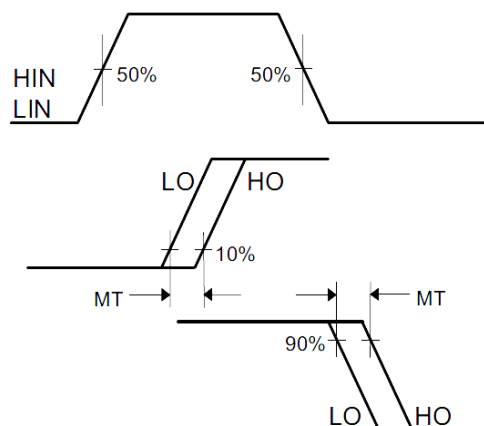
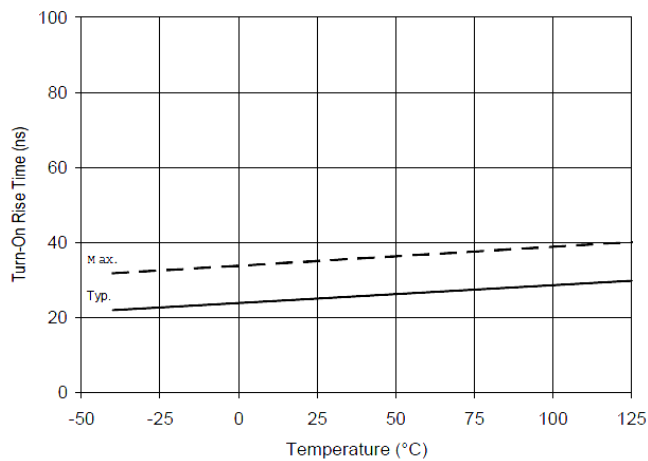
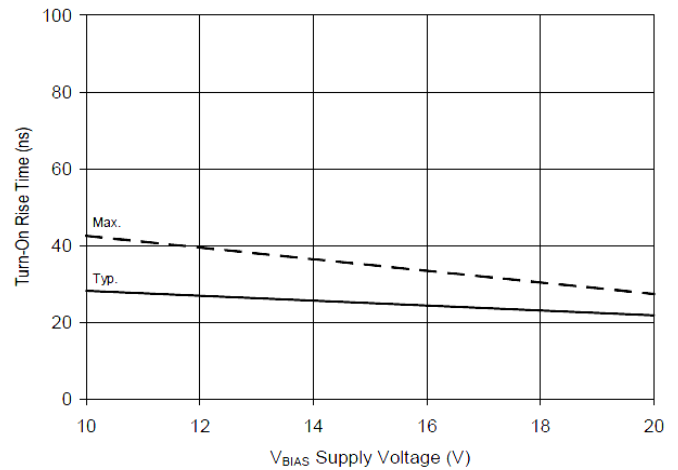
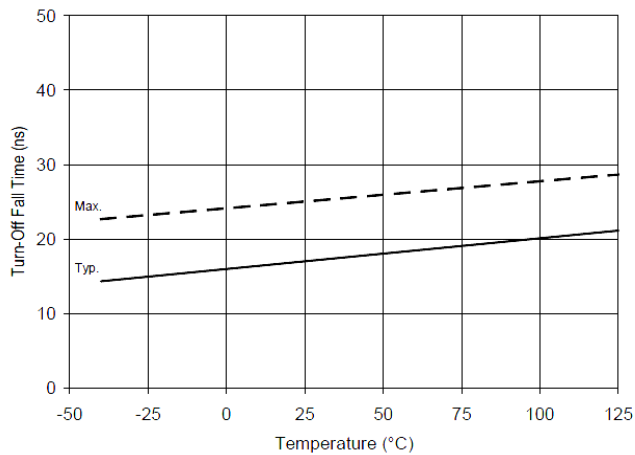
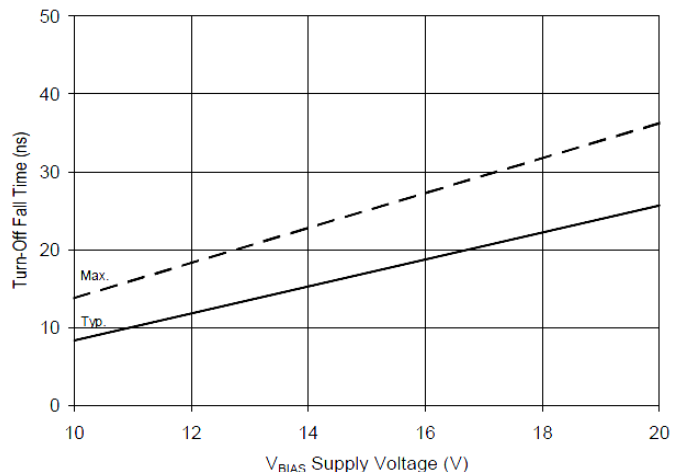
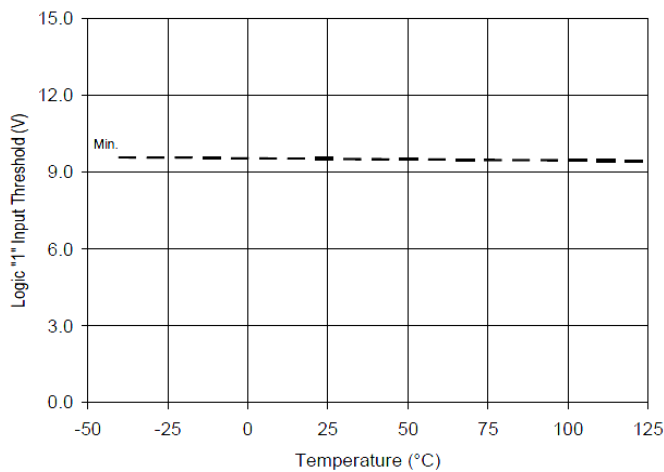
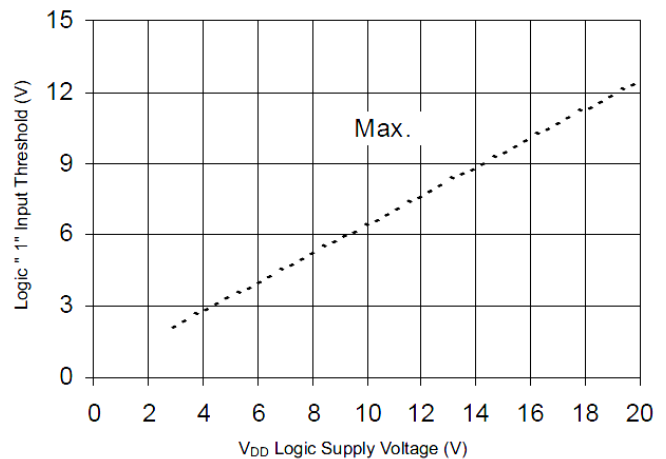
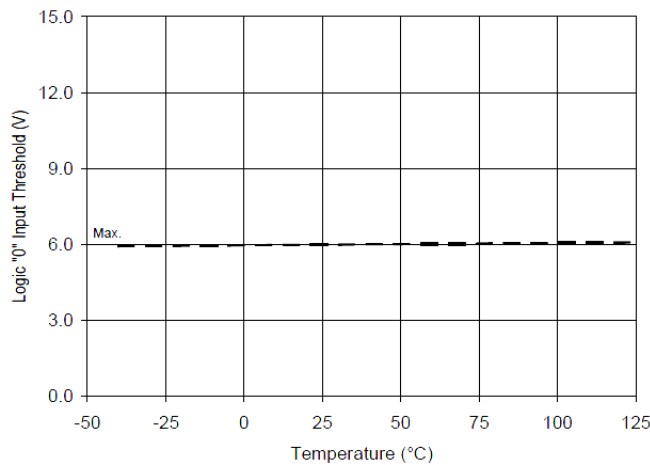
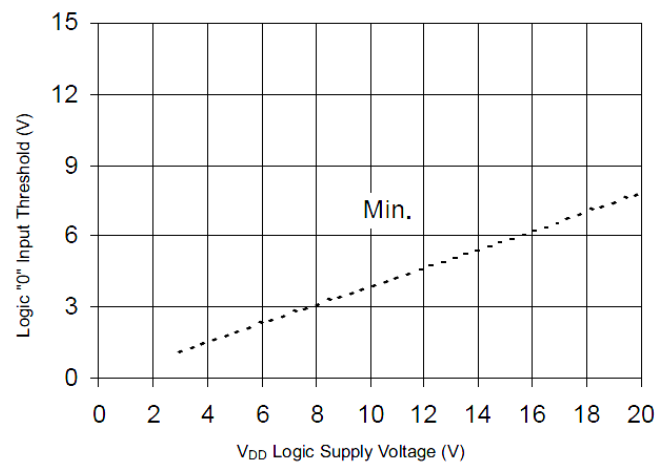
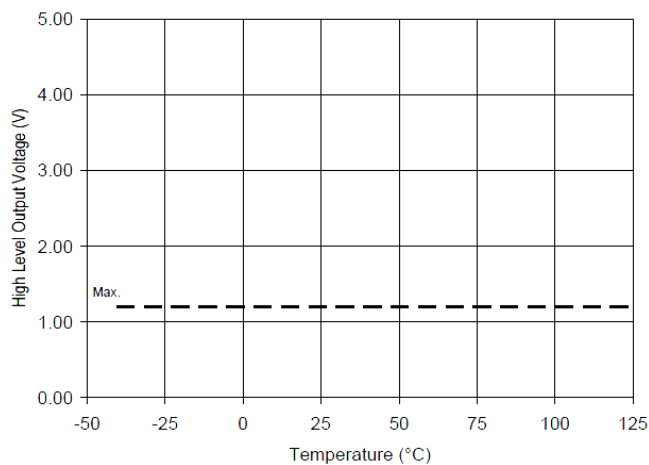
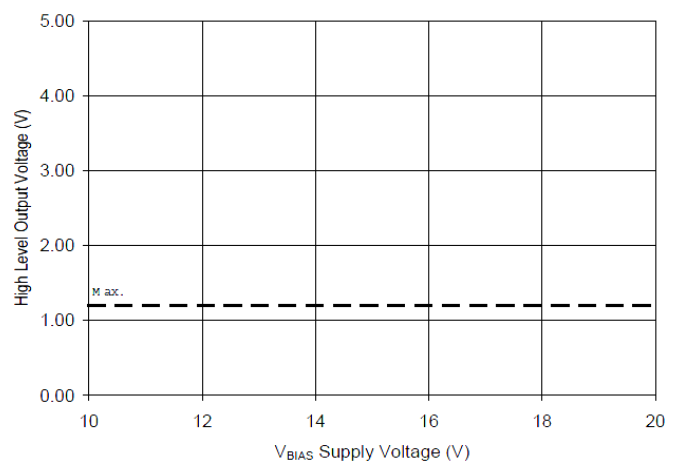
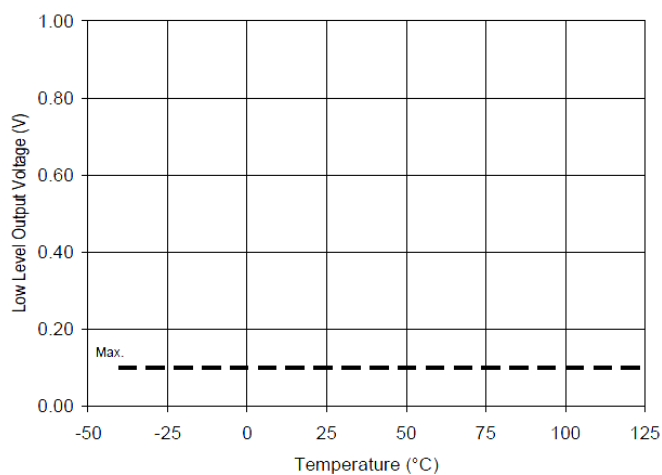
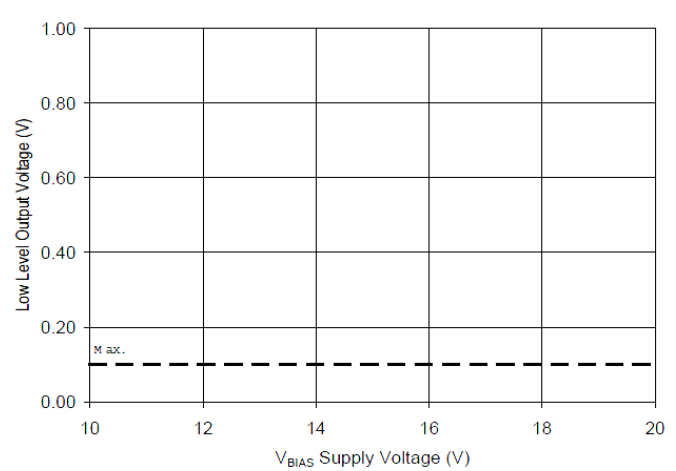
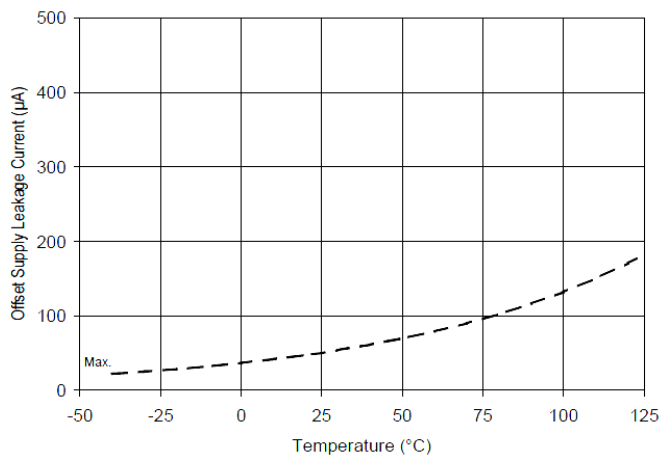
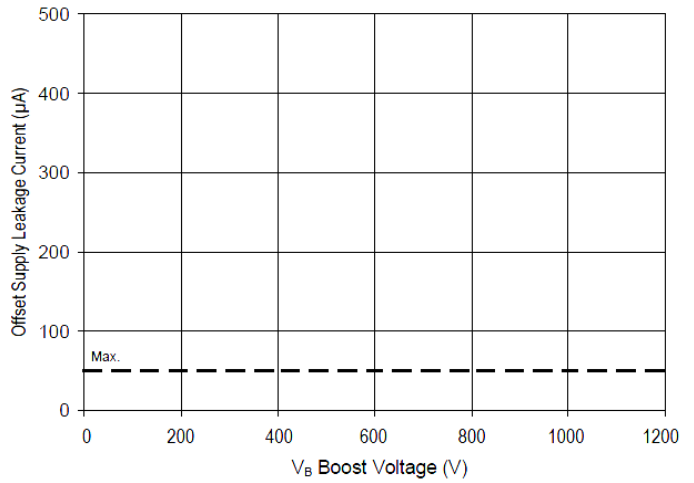
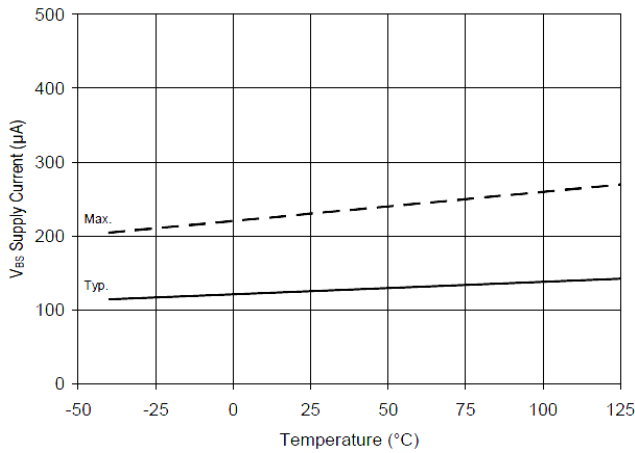
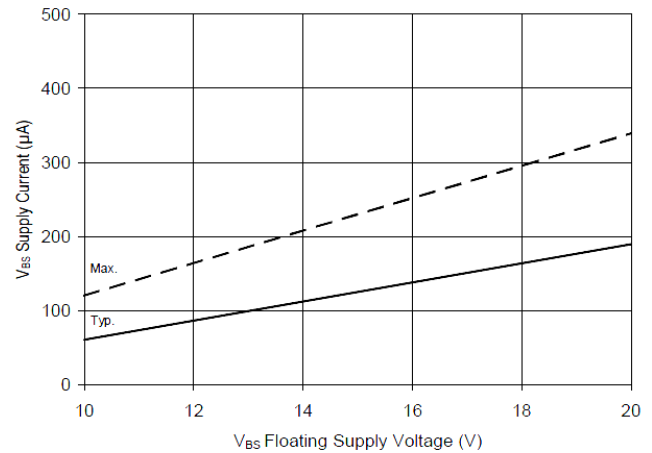
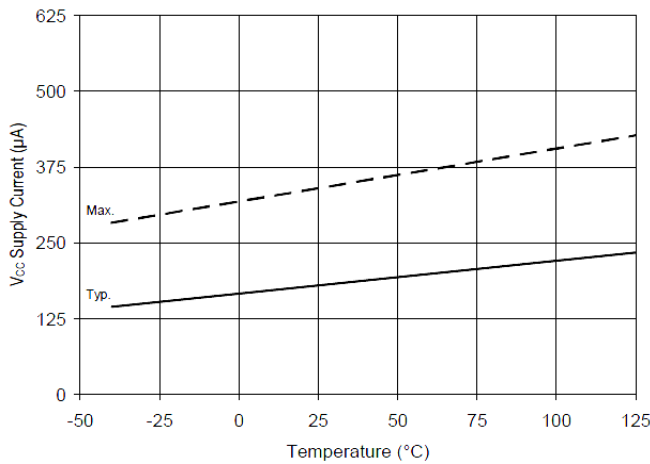
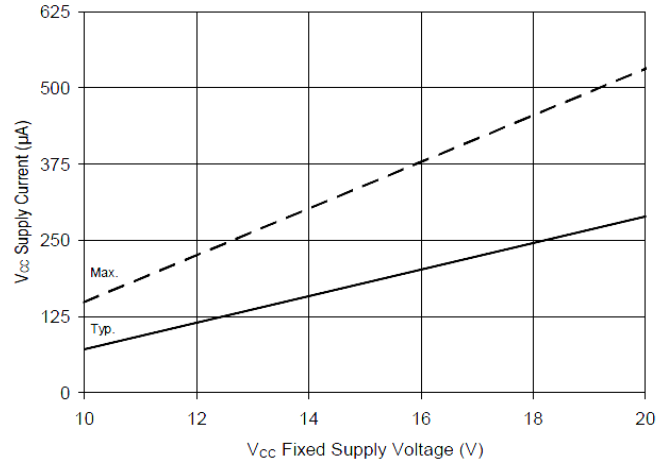
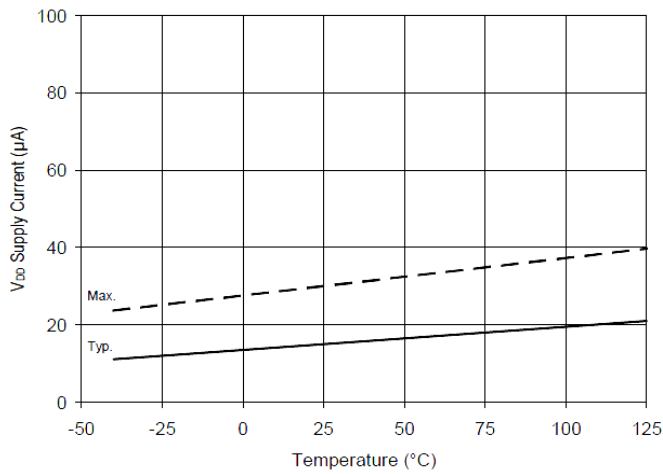
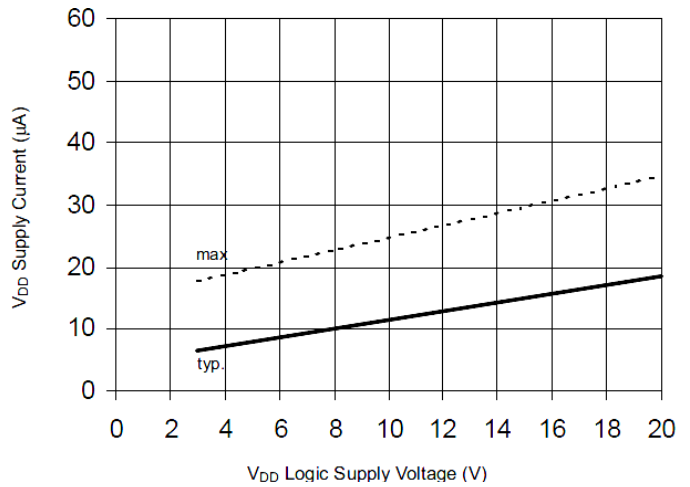
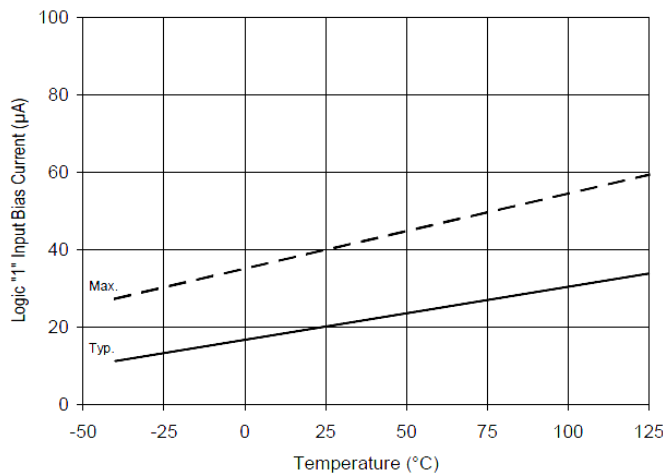
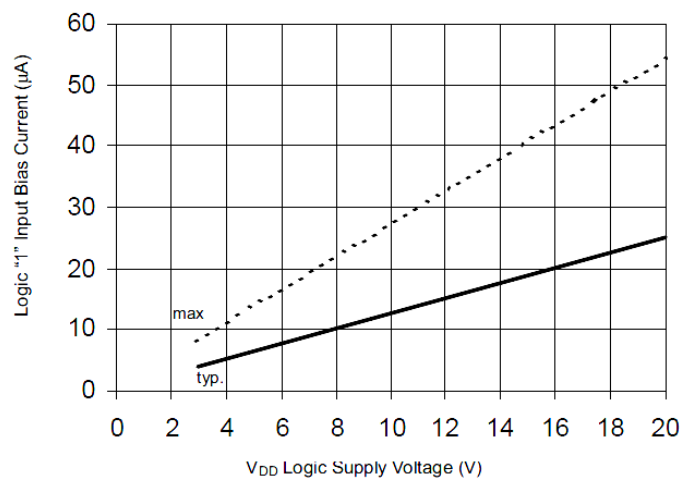
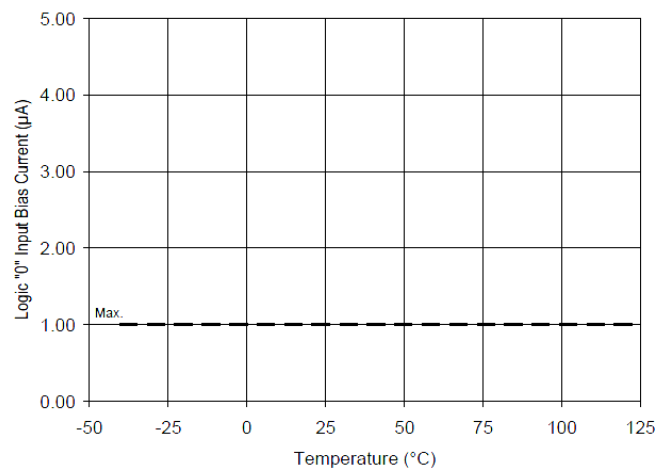
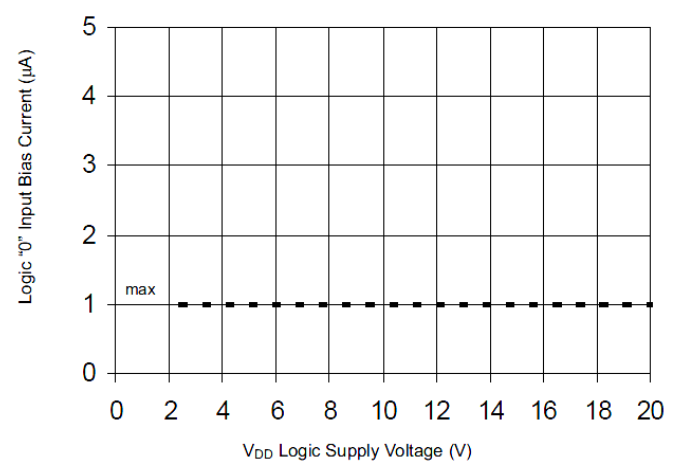


Figure 6. Delay Matching Waveform Definitions


Figure 7A. Turn-On Rise Time vs. Temperature

Figure 7B. Turn-On Rise Time vs. Voltage

Figure 8A. Turn-Off Fall Time vs. Temperature

Figure 8B. Turn-Off Fall Time vs. Voltage

Figure 9A. Logic "1" Input Threshold vs. Temperature

Figure 9B. Logic "1" Input Threshold vs. Voltage


Figure 10A. Logic "0" Input Threshold vs. Temperature

Figure 10B. Logic "0" Input Threshold vs. Voltage

Figure 11A. High Level Output vs. Temperature

Figure 11B. High Level Outputs vs. Voltage

Figure 12A. Low Level Output vs. Temperature

Figure 12B. Low Level Output vs. Voltage


Figure 13A. Offset Supply Current vs. Temperature

Figure 13B. Offset Supply Current vs. Voltage

Figure 14A. V_{BS} Supply Current vs. Temperature

Figure 14B. V_{BS} Supply Current vs. Voltage

Figure 15A. V_{CC} Supply Current vs. Temperature

Figure 15B. V_{CC} Supply Current vs. Voltage


Figure 16A. V_{DD} Supply Current vs. Temperature

Figure 16B. V_{DD} Supply Current vs. V_{DD} Voltage

Figure 17A. Logic "1" Input Current vs. Temperature

Figure 17B. Logic "1" Input Current vs. V_{DD} Voltage

Figure 18A. Logic "0" Input Current vs. Temperature

Figure 18B. Logic "0" Input Current vs. V_{DD} Voltage

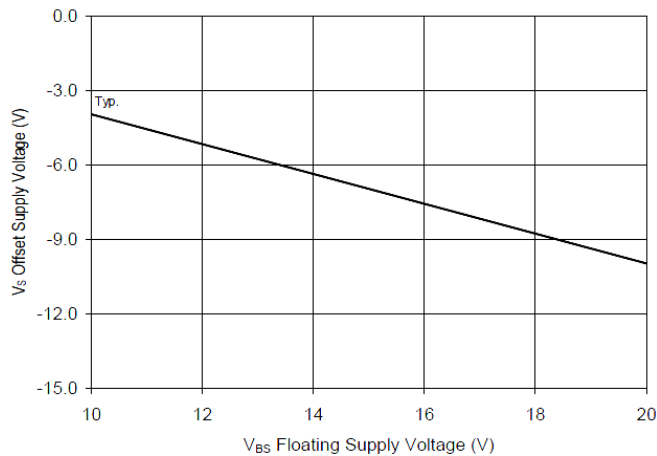


Figure 19. Maximum V_S Negative Offset vs. V_{BS} Supply Voltage

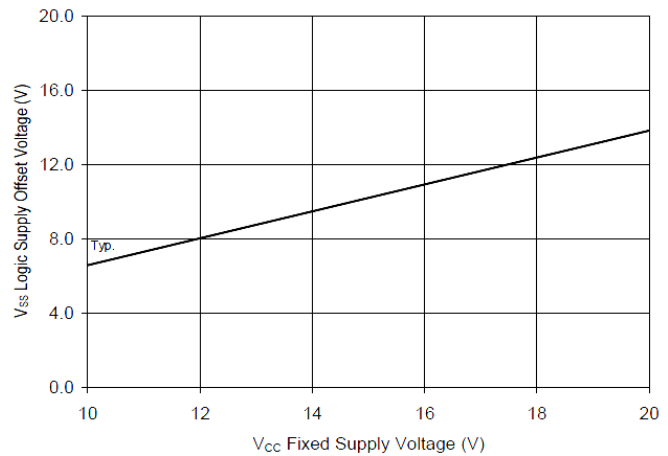


Figure 20. Maximum V_{SS} Positive Offset vs. V_{CC} Supply Voltage

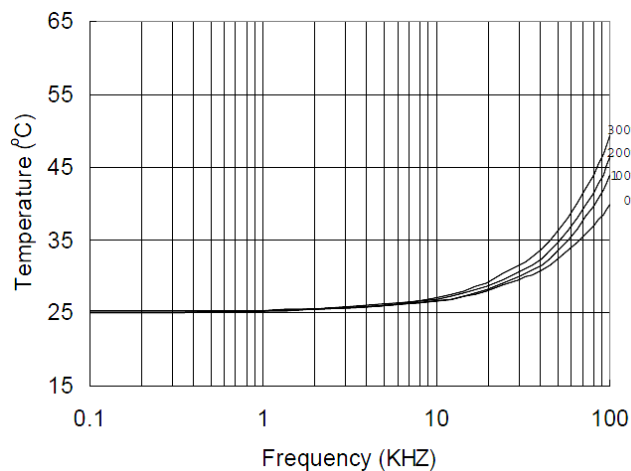


Figure 21. IR2213S vs. Frequency (IRFBC20)
R_{gate}=33Ω, V_{CC}=15V

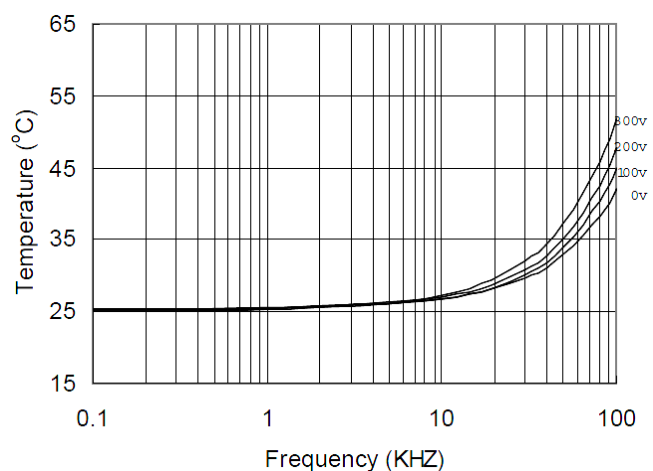


Figure 22. IR2213S vs. Frequency (IRFBC30)
R_{gate}=22Ω, V_{CC}=15V

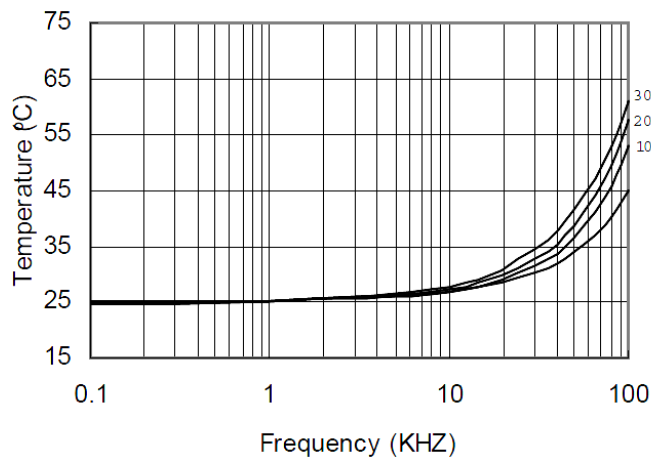


Figure 23. IR2213S vs. Frequency (IRFBC40)
 $R_{gate}=15\Omega$, $V_{CC}=15V$

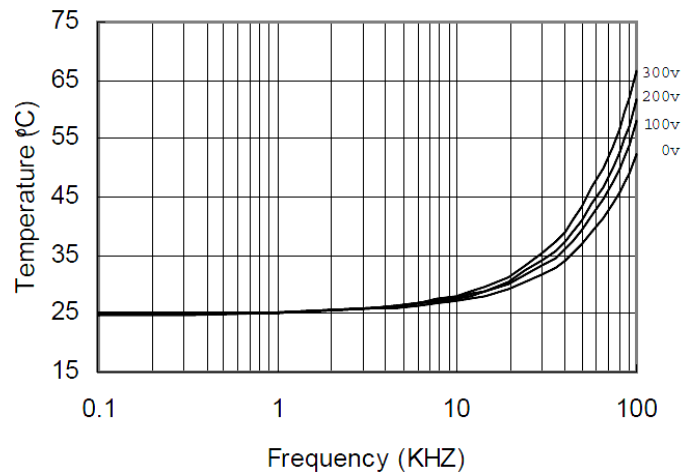


Figure 24. IR2213S vs. Frequency (IRFBC50)
 $R_{gate}=10\Omega$, $V_{CC}=15V$

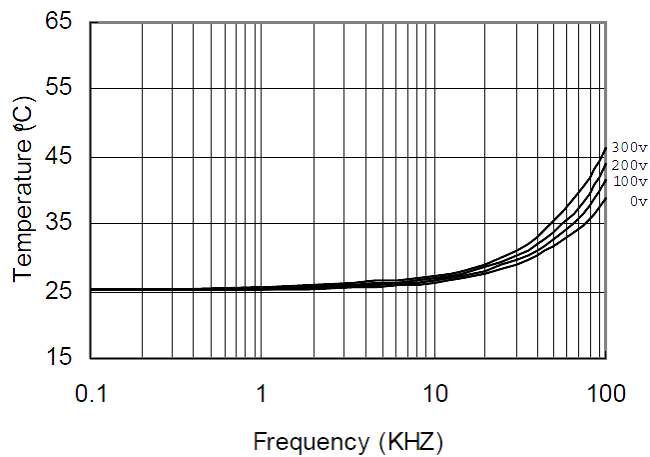


Figure 25. IR2213 vs. Frequency (IRFBC20)
 $R_{gate}=33\Omega$, $V_{CC}=15V$

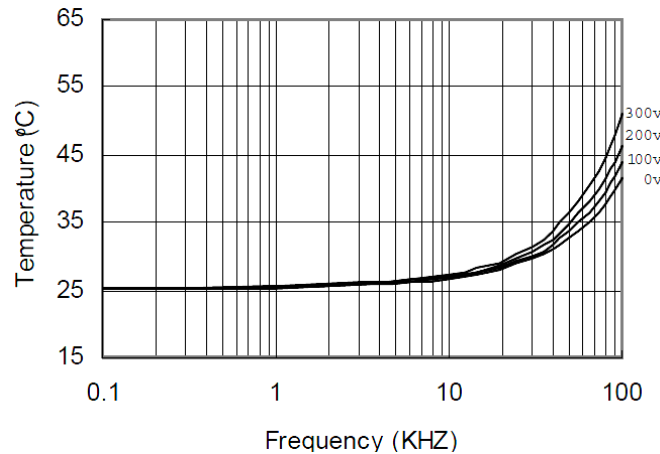


Figure 26. IR2213 vs. Frequency (IRFBC30)
 $R_{gate}=22\Omega$, $V_{CC}=15V$

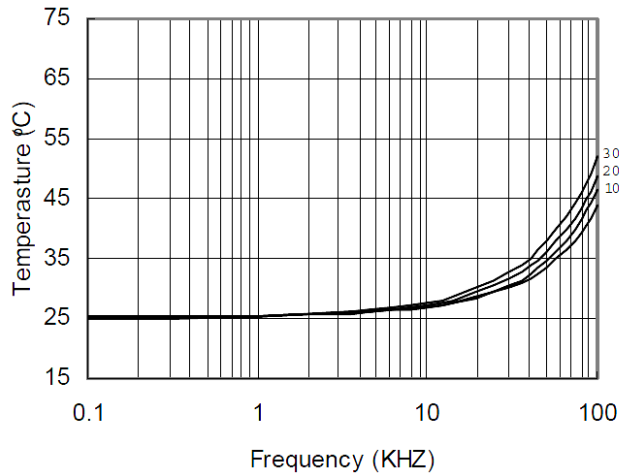


Figure 27. IR2213 vs. Frequency (IRFBC40)
 $R_{gate}=15\Omega$, $V_{CC}=15V$

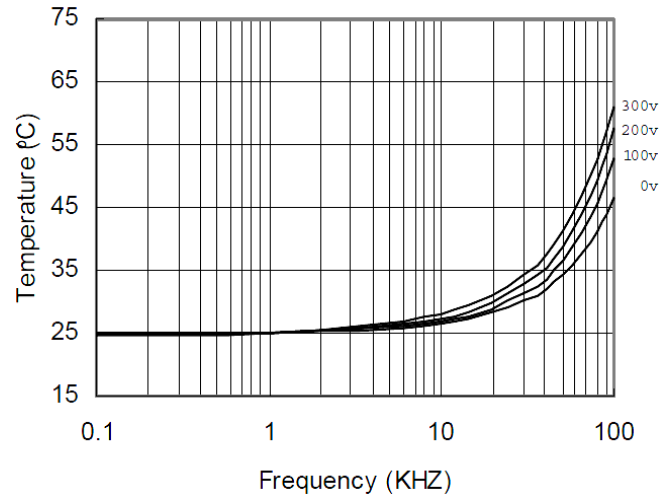
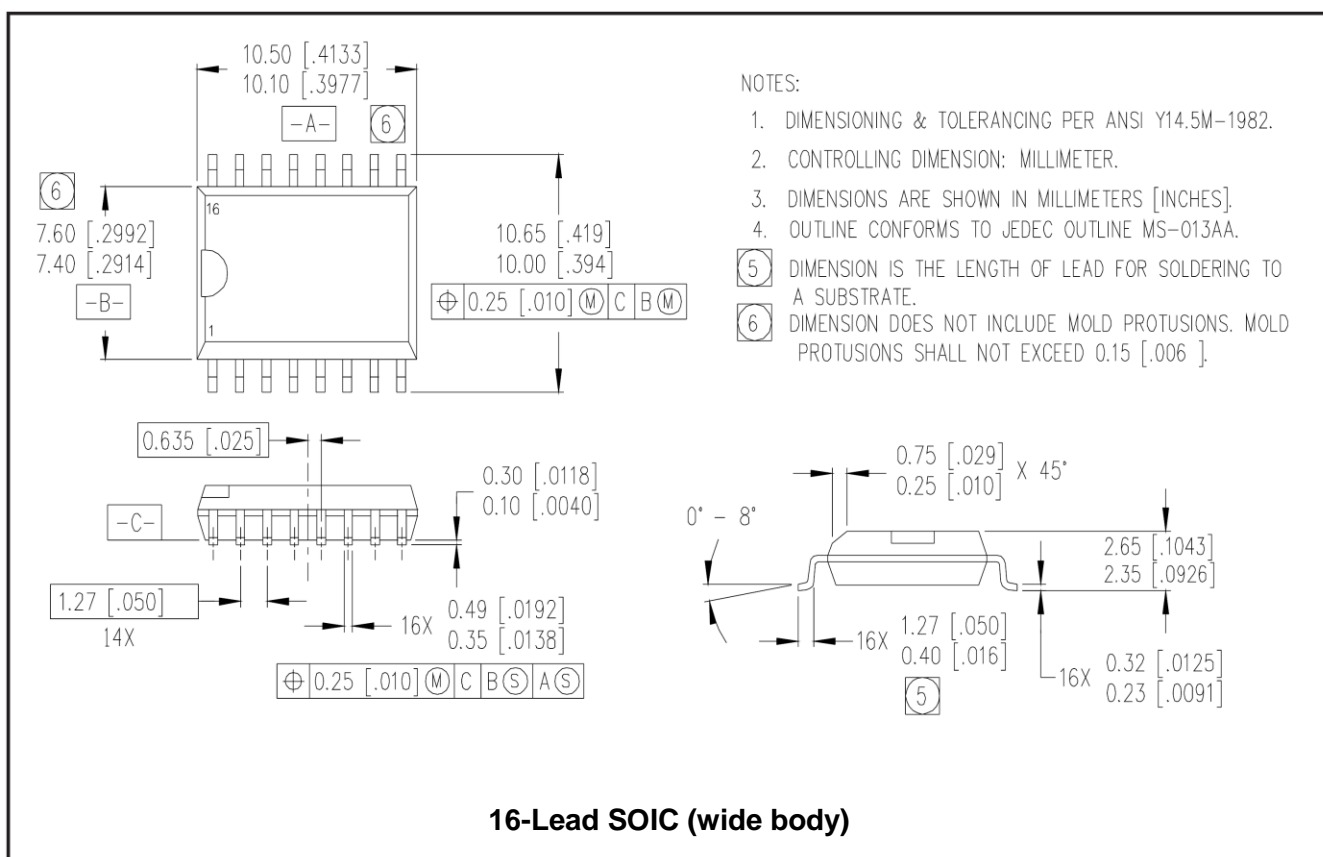
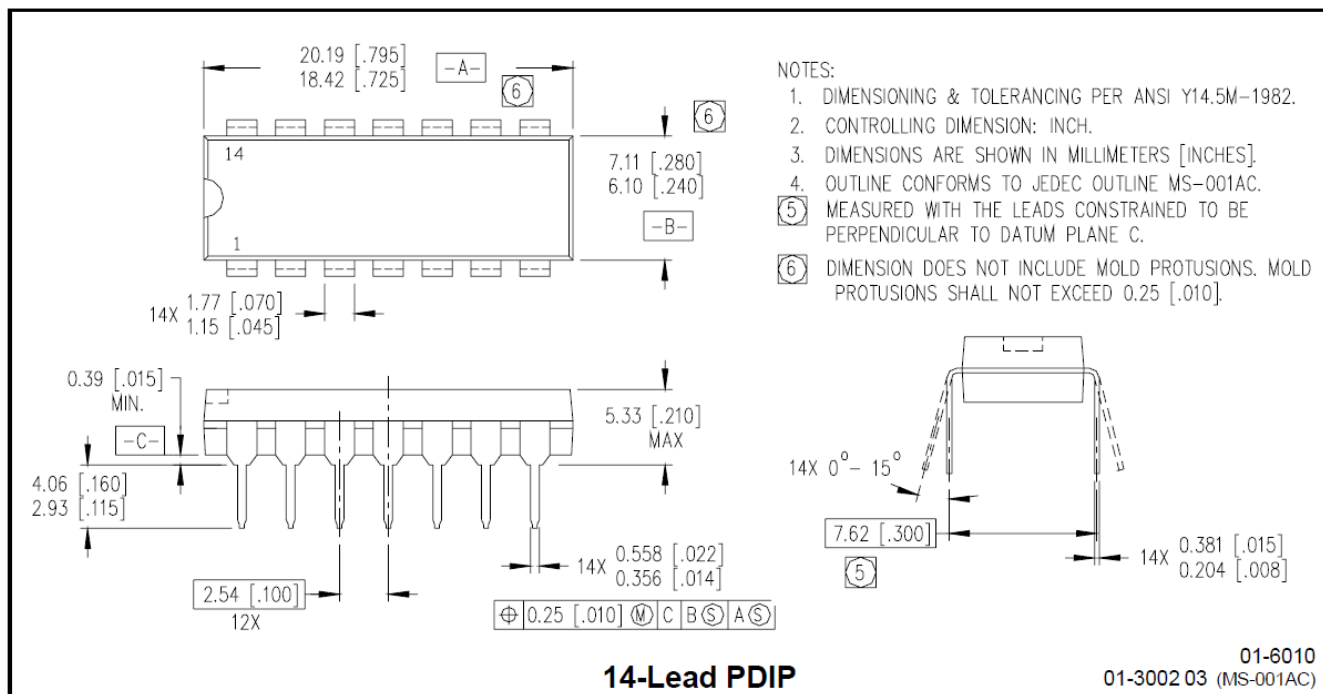
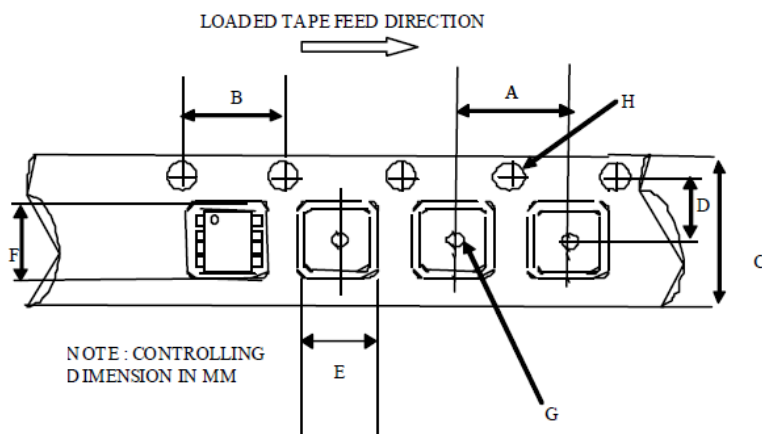


Figure 28. IR2213 vs. Frequency (IRFBC50)
 $R_{gate}=10\Omega$, $V_{CC}=15V$

Package Details

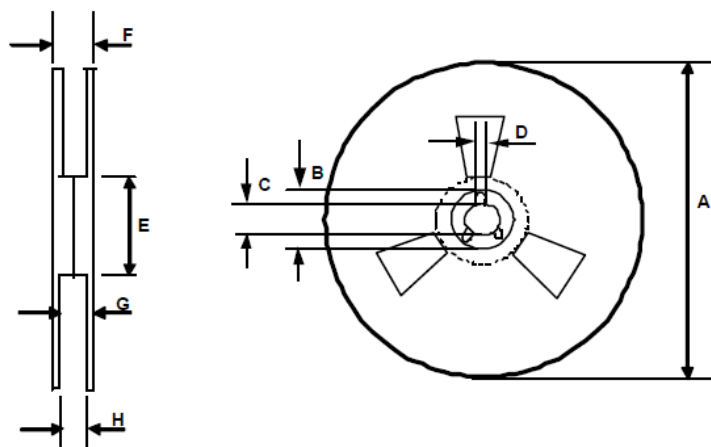


Tape and Reel Details, SO16WB



CARRIER TAPE DIMENSION FOR 16SOICW

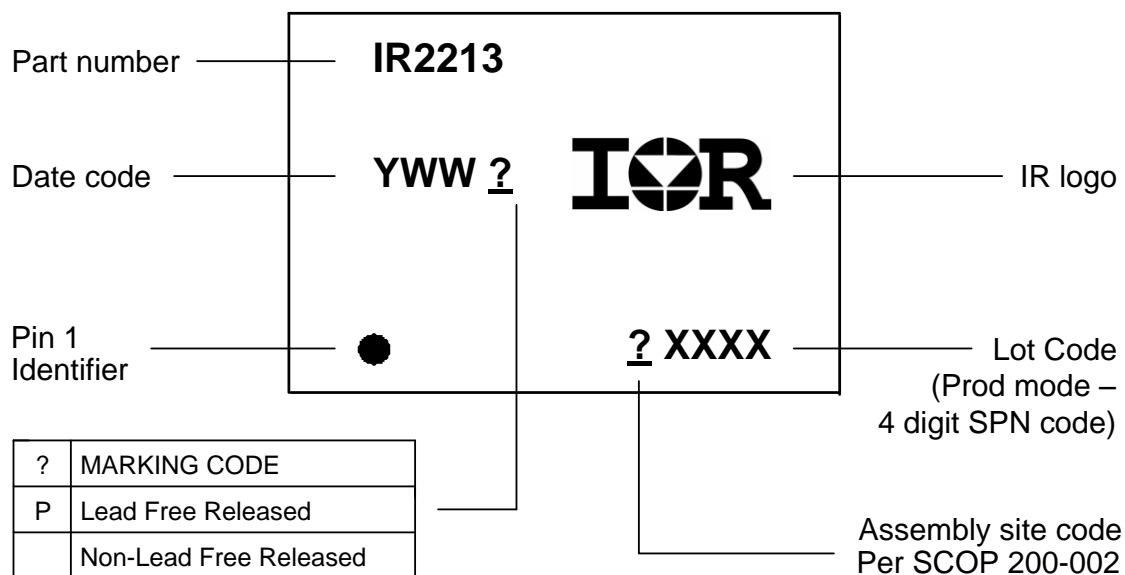
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	Min	Max	Min	Max
A	11.90	12.10	0.468	0.476
B	3.90	4.10	0.153	0.161
C	15.70	16.30	0.618	0.641
D	7.40	7.60	0.291	0.299
E	10.80	11.00	0.425	0.433
F	10.60	10.80	0.417	0.425
G	1.50	n/a	0.059	n/a
H	1.50	1.60	0.059	0.062



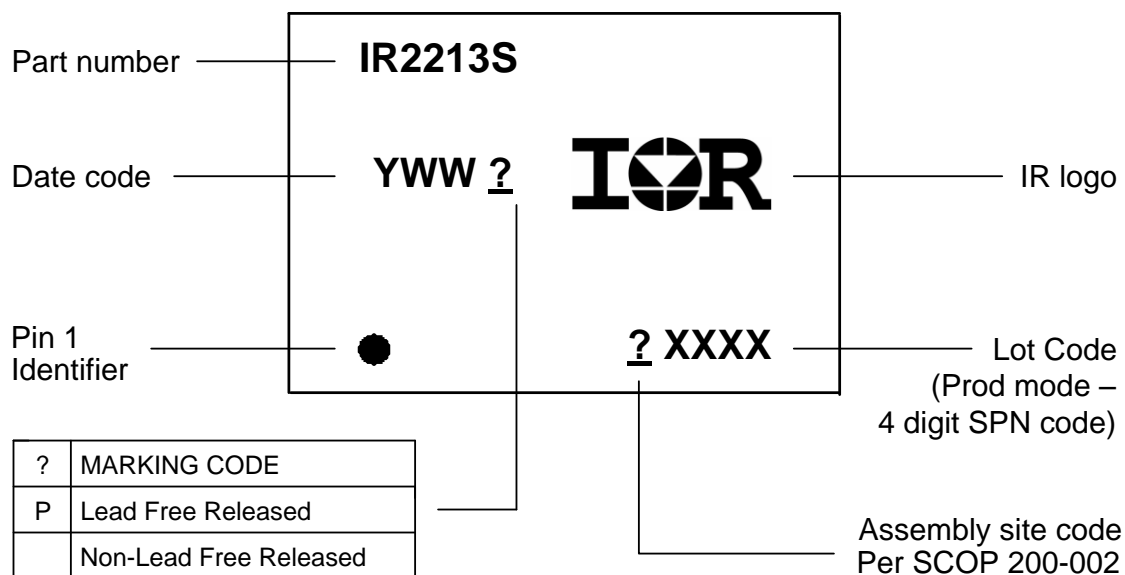
REEL DIMENSIONS FOR 16SOICW

Code	Metric		Imperial	
	Min	Max	Min	Max
A	329.60	330.25	12.976	13.001
B	20.95	21.45	0.824	0.844
C	12.80	13.20	0.503	0.519
D	1.95	2.45	0.767	0.096
E	98.00	102.00	3.858	4.015
F	n/a	22.40	n/a	0.881
G	18.50	21.10	0.728	0.830
H	16.40	18.40	0.645	0.724

Part Marking Information



14-Lead PDIP



16-Lead SOIC (wide body)

Qualification Information[†]

Qualification Level	Industrial ^{††} (per JEDEC JESD 47)	
	Comments: This family of ICs has passed JEDEC's Industrial qualification. IR's Consumer qualification level is granted by extension of the higher Industrial level.	
Moisture Sensitivity Level	SOIC16WB	MSL3 ^{†††} (per IPC/JEDEC J-STD 020)
	PDIP14	Not applicable (non-surface mount package style)
RoHS Compliant	Yes	

† Qualification standards can be found at International Rectifier's web site <http://www.irf.com/>

†† Higher qualification ratings may be available should the user have such requirements. Please contact your International Rectifier sales representative for further information.

††† Higher MSL ratings may be available for the specific package types listed here. Please contact your International Rectifier sales representative for further information.

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<http://www.irf.com/technical-info/>

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